EVERLIGHT

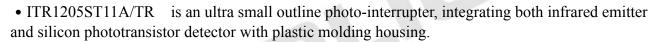
DATASHEET

Technical Data Sheet Opto Interrupter ITR1205ST11A/TR

Features

- Gap: 1.1 mm
- Slit : 0.3 mm
- Compact SMD Package
- Pb/Halogens free
- RoHS compliant

Description



Applications

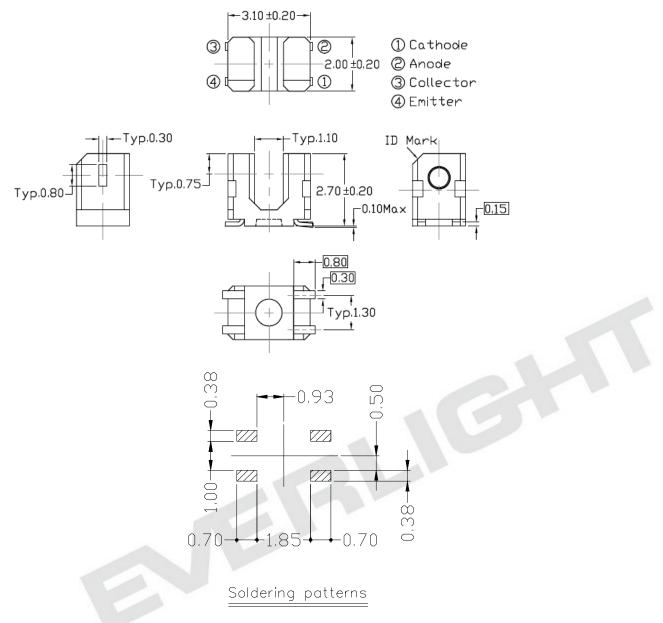
- Printer
- Digital Camera
- Optical switch

Device Selection Guide

| Device No. | Chip Material | | |
|------------|---------------|--|--|
| IR | AlGaAs | | |
| PT | Silicon | | |



Package Dimensions



Notes: 1.All dimensions are in millimeters 2.Tolerances unless dimensions ±0.1mm

Absolute Maximum Ratings (Ta=25)

| | Parameter | Symbol | Rating | Unit |
|--|---|--------------------|----------|------|
| Input | Power Dissipation at(or below) 25 Free Air Temperature | Pd | 75 | mW |
| | Reverse Voltage | V _R | 5 | V |
| | Forward Current | I_F | 50 | mA |
| | Peak Forward Current * ¹ | I _{FP} | 1 | Α |
| Output | Collector Power Dissipation | P _C | 75 | mW |
| | Collector Current | I _C | 20 | mA |
| | Collector-Emitter Voltage | B V _{CEO} | 35 | V |
| | Emitter-Collector Voltage | B V _{ECO} | 6 | V |
| Operating Temperature | | Topr | -40~+85 | |
| Storage Temperature | | Tstg | -40~+100 | |
| Lead Soldering Temperature ^{*2} | | Tsol | 260 | |

* 1. Pulse width tw =100µs, Period T=10ms * 2 t 5sec.

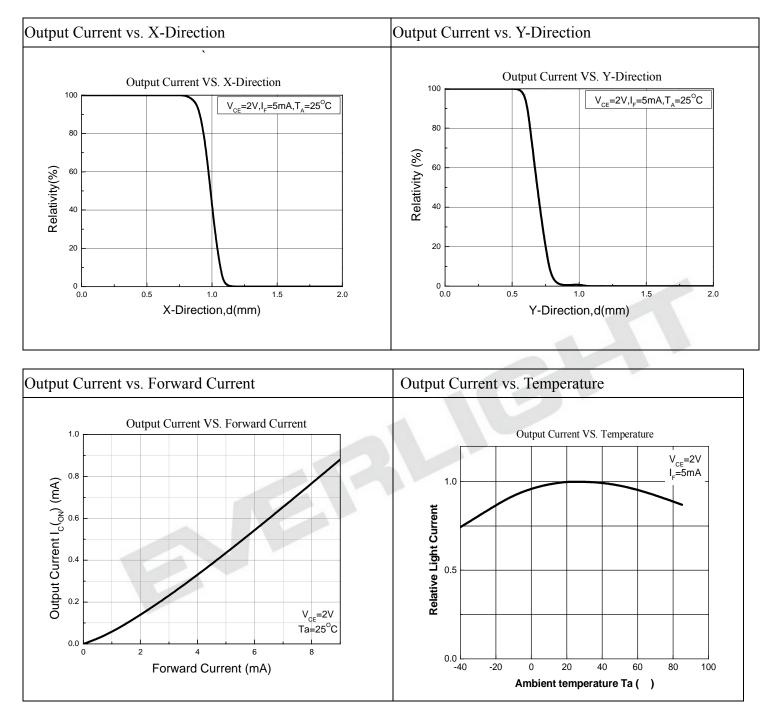
Electro-Optical Characteristics (Ta=25)

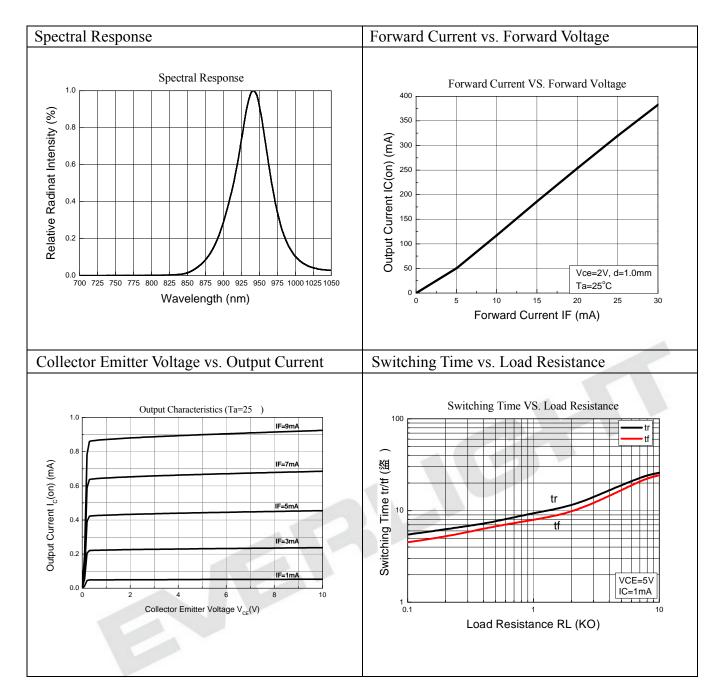
| Parameter | | Symbol | Min. | Тур. | Max. | Unit | Condition |
|-----------------------------|------------------------|------------------------|------|------|------|------|---|
| Input | Forward Voltage | V _F | | 1.2 | 1.4 | V | I _F =20mA |
| | Reverse Current | I _R | | | 10 | μΑ | V _R =6V |
| | Peak Wavelength | λ_{P} | | 940 | | nm | I _F =20mA |
| Output | Dark Current | I _{CEO} | | | 0.1 | μΑ | V _{CE} =20V |
| | C-E Saturation voltage | V _{CE(sat)} | | | 0.4 | V | $I_c=0.05mA$ $I_F=10mA$ |
| Transfer Characteristics | Collector Current | I _{C(ON)} | 150 | | 1000 | μΑ | V _{CE} =2V, I _F =5mA |
| | Rise time | t _r | | 9 | | μs | V _{CE} =5V I _C =1mA |
| | Fall time | t _f | | 8 | | μs | $R_L=1K\Omega$ |

LifecyclePhase:

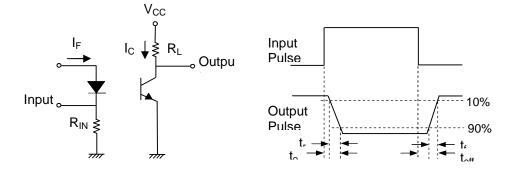
Approved

Typical Electrical/Optical/Characteristics Curves

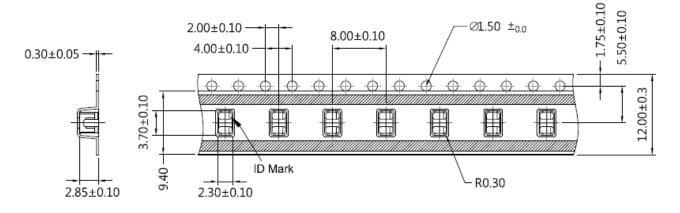




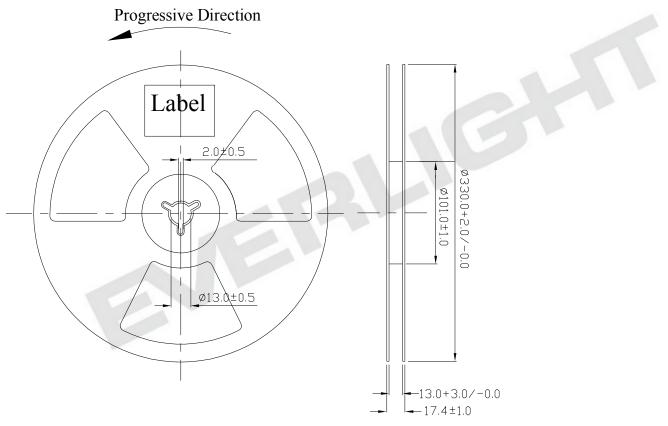
Measuring Circuit For Response Time



Taping Dimension



Reel Dimensions



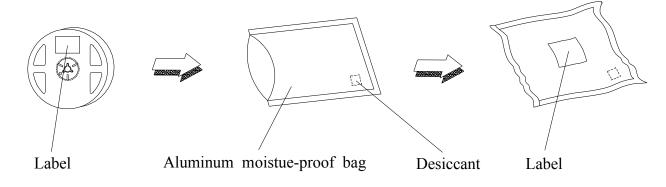
Note: The tolerances unless mentioned is ± 1.0 mm ,Unit = mm

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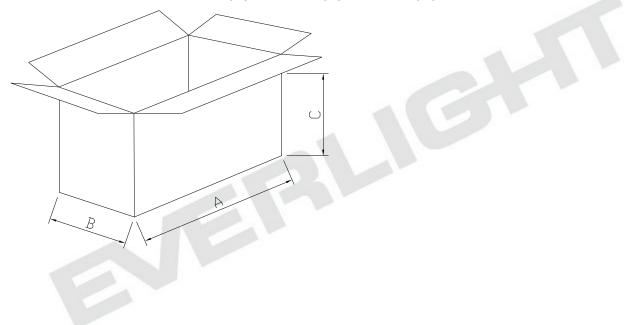
Packing Quantity Specification

1. 3000pcs / 1 Reel 2.13 Reels (39Kpcs) / 1 Carton

Packing Procedure



Outer Carton Dimension : 409mm(A)*245mm(B)*360mm(C)



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Precautions For Use

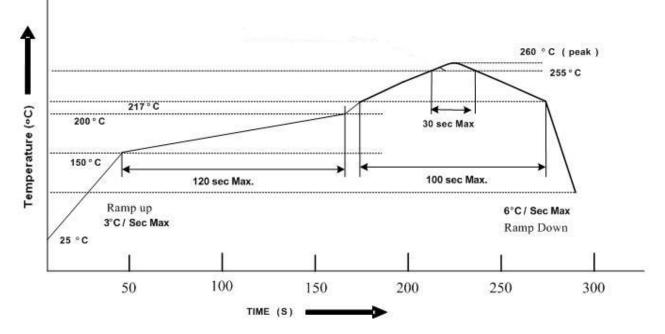
The following are general recommendations for moisture sensitive level (MSL) 3 storage and use :

- 1. Storage
- 1.1 Do not open moisture proof bag before the products are ready to use.
- 1.2 Before opening the package, the device should be kept at 30 or less and 90%RH or less.
- 1.3 The device should be used within a year.
- 1.4 After opening the package, the device should be kept at 30 or less and 70%RH or less.
- 1.5 The device should be used within 168 hours (7 days) after opening the package.
- 1.6 If the moisture absorbent material (silica gel) has faded away or the device have exceeded the

storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60 ± 5 for 24 hours.

- 2. Soldering Condition
- 2.1 Pb-free solder temperature profile



- 2.2 Reflow soldering should not be done more than two times.
- 2.3 When soldering, do not put stress on the device during heating.
- 2.4 After soldering, do not warp the circuit board.

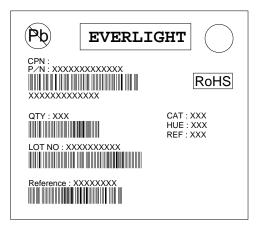
3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

4. Repairing

Repair should not be done after the device have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the device will or will not be damaged by repairing.

Label Form Specification



CPN: Customer's Production Number P/N : Production Number QTY: Packing Quantity CAT: Ranks HUE: Peak Wavelength REF: Reference LOT No: Lot Number MADE IN TAIWAN: Production Place

Notes

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 3. These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.

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